

# **DSA612**

# **Two-Output Low Power MEMS Clock Generator for Automotive**

#### Features

- Automotive AEC-Q100 Qualified
- MEMS-Based Clock Generator Eliminates the Need for External Crystal or Reference Clock
- Two LVCMOS Output Clocks: 2 kHz to 100 MHz
- Low Power Consumption: ~5 mA (Both Outputs Active)
- Wide Supply Voltage Range: 1.71V to 3.63V
- Ultra-Small Package Sizes:
  - 1.6 mm x 1.2 mm
  - 2.0 mm x 1.6 mm
  - 2.5 mm x 2.0 mm
- High Frequency Stability: ±20 ppm, ±25 ppm, ±50 ppm
- Wide Temperature Range:
  - Automotive (Grade 1): -40°C to +125°C
  - Automotive (Grade 2): -40°C to +105°C
  - Automotive (Grade 3): -40°C to +85°C
- Excellent Shock and Vibration Immunity:
  - Shock: Qualified to MIL-STD-883E Method 2002.3. Test Condition G (30,000g)
  - Vibration: Qualified to MIL-STD-883E Method 2007.2, Test Condition C (70g)
- Spread Spectrum Clock Generation for EMI Reduction
- High Reliability
- · Lead-Free and RoHS-Compliant

#### **Applications**

- Automotive Infotainment
- Automotive ADAS, Surround View Cameras
- In-Vehicle Networking, CAN bus, Ethernet

#### **General Description**

The DSA612 is a MEMS low power, ultra-small footprint, crystal-less family of clock generators. The DSA612 family is factory-configurable and generates up to two independent LVCMOS outputs. Each output can be configured to generate any frequency from 2 kHz to 100 MHz. The two-output DSA612 MEMS oscillators are excellent choices for use as clock references in automotive applications in which small size, low power consumption, and long-term reliability are paramount. The family of devices is AEC-Q100 qualified.

The DSA612 implements Microchip's proven PureSilicon<sup>™</sup> MEMS technology to provide low jitter and high stability across a wide range of supply voltages and temperatures. By eliminating the external quartz crystal, Microchip's crystal-less<sup>™</sup> clock generators significantly enhance reliability and accelerate product development.

The DSA612 has two control inputs that can be configured to function as output enable/disable, standby, sleep, spread spectrum enable, and frequency select. The DSA612 is available in space saving 6-pin, 1.6 mm x 1.2 mm, 2.0 mm x 1.6 mm, and 2.5 mm x 2.0 mm VFLGA plastic packages.

The DSA612 spread spectrum function includes both center and down spreading, and is explained further in the Spread Spectrum section.

The DSA612 is a highly configurable device and is factory programmed to meet the customer's needs. Microchip's ClockWorks Configurator must be used to choose the necessary options, create the final part number, data sheet, and order samples.

#### Package Type



# **Functional Block Diagram**



# 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings †

Supply Voltage	
Input Voltage	
ESD Protection (HBM)	
ESD Protection (MM)	
ESD Protection (CDM)	

**† Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

# **ELECTRICAL CHARACTERISTICS**

<b>Electrical Characteristics:</b> $V_{DD} = 1.8V \pm 5\%$ to 3.3V $\pm 10\%$ ; $I_A = -40^{\circ}$ C to $\pm 125^{\circ}$ C, unless noted.								
Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
Supply Voltage	V <sub>DD</sub>	1.71		3.63	V	Note 1		
Active Supply Current	I <sub>DD</sub>		5	6	mA	$f_{CLK1}$ = 27 MHz, $f_{CLK2}$ = 25 MHz, V <sub>DD</sub> = 1.8V, No Load		
Active Supply Current (Sleep Mode, 1 PLL Off)	I <sub>DDSL</sub>		3	_	mA	CLK2 = SLEEP, $f_{CLK1}$ = 25 MHz, V <sub>DD</sub> = 1.8V, No Load		
Active Supply Current (32.768 kHz Output Only)	I <sub>DD32k</sub>		1.4	_	mA	CLK2 = SLEEP, f <sub>CLK1</sub> = 32.768 kHz, V <sub>DD</sub> = 1.8V, No Load		
Standby Supply Current,		—	1.0	—		V <sub>DD</sub> = 1.8V/2.5V		
Note 2	ISTDBY	_	1.5	—	μA	V <sub>DD</sub> = 3.3V		
		_	_	±20				
Frequency Stability, Note 3	Δf	_		±25	ppm	All temperature ranges		
		_		±50				
Aging	Δf	_	_	±5		1st year @ +25°C		
Aging	Δι	_		±1	ppm	Per year after the first year		
Startup Time	t <sub>SU</sub>		_	1.5	ms	From 90% V <sub>DD</sub> to valid clock output, T = +25°C		
Input Logic Loucle, Note 4	V <sub>IH</sub>	0.7 x V <sub>DD</sub>		_	V	Input logic high		
Input Logic Levels, Note 4	V <sub>IL</sub>		_	0.3 x V <sub>DD</sub>	V	Input logic low		
Output Disable Time	t <sub>DA</sub>		_	200 + 2 Periods	ns	Note 5		
Output Enable Time	t <sub>EN</sub>	—	1.0	—	μs	Note 6		
Enable Pull-Up Resistor	—	—	300	—	kΩ	Note 7		
Output Logic Levels	V <sub>OHY</sub>	0.8 x V <sub>DD</sub>	_	_	V	I = 6 mA (high drive) or I = 3 mA (standard drive)		
Output Logic Levels	V <sub>OLY</sub>		_	0.2 x V <sub>DD</sub>	v	I = -6  mA (high drive) or $I = -3  mA$ (standard drive)		

Electrical Characteristics: V<sub>DD</sub> = 1.8V ±5% to 3.3V ±10%; T<sub>A</sub> = -40°C to +125°C, unless noted.

# ELECTRICAL CHARACTERISTICS (CONTINUED)

**Electrical Characteristics:**  $V_{DD}$  = 1.8V ±5% to 3.3V ±10%;  $T_A$  = -40°C to +125°C, unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Output Transition Time, Rise	t <sub>RY1</sub> /t <sub>FY1</sub>	_	1.2	2.0	ns	Standard drive 20% - 80% C <sub>L</sub> = 10 pF, V <sub>DD</sub> = 1.8V
		_	0.6	1.2	ns	Standard drive 20% - 80% C <sub>L</sub> = 10 pF, V <sub>DD</sub> = 2.5V/3.3V
Time/Fall Time	t <sub>RY2</sub> /t <sub>FY2</sub>		1.0	1.5	ns	High drive 20% - 80% C <sub>L</sub> = 15 pF, $V_{DD}$ = 1.8V
			0.5	1.0	ns	High drive 20% - 80% C <sub>L</sub> = 15 pF, V <sub>DD</sub> = 2.5V/3.3V
Frequency	fO	0.002		100	MHz	_
Output Duty Cycle	SYM	45		55	%	—
	J <sub>PER</sub>	_	17	_		f <sub>CLK1</sub> = 24 MHz, f <sub>CLK2</sub> = 27 MHz, V <sub>DD</sub> = 1.8V
Period Jitter, RMS		_	14	—	ps	$f_{CLK1}$ = 24 MHz, $f_{CLK2}$ = 27 MHz, V <sub>DD</sub> = 3.3V
			9	_		$f_{CLK1}$ = 27 MHz, $f_{CLK2}$ = 27 MHz or 32.768 kHz, $V_{DD}$ = 3.3V
	J <sub>PER</sub>	_	120	_	ps	f <sub>CLK1</sub> = 24 MHz, f <sub>CLK2</sub> = 27 MHz, V <sub>DD</sub> = 1.8V
Period Jitter, Peak-to-Peak		_	100	—		$f_{CLK1}$ = 24 MHz, $f_{CLK2}$ = 27 MHz, V <sub>DD</sub> = 3.3V
			80	—		$f_{CLK1} = 27 \text{ MHz}, f_{CLK2} = 27 \text{ MHz} \text{ or}$ 32.768 kHz, V <sub>DD</sub> = 3.3V
			105			$f_{CLK1}$ = 24 MHz, $f_{CLK2}$ = 27 MHz, V <sub>DD</sub> = 1.8V
Cycle-to-Cycle Jitter (peak)	J <sub>Cy-Cy</sub>	_	90	_	ps	$f_{CLK1}$ = 24 MHz, $f_{CLK2}$ = 27 MHz, V <sub>DD</sub> = 3.3V
		_	70	_		$f_{CLK1} = 27 \text{ MHz}, f_{CLK2} = 27 \text{ MHz} \text{ or}$ 32.768 kHz, V <sub>DD</sub> = 3.3V

**Note 1:**  $V_{DD}$  pin should be filtered with a 0.1  $\mu$ F capacitor.

- 2: Excludes input pull-up current.
- 3: Includes frequency variations due to initial tolerance, temperature, and power supply voltage.
- **4:** Input waveform must be monotonic with rise/fall time < 10 ms.
- 5: Output disable time takes up to two Periods of the output waveform, plus 200 ns.
- 6: For parts configured with OE, not Standby.
- 7: Output is enabled if pad is floated or not connected.

# **TEMPERATURE SPECIFICATIONS (Note 1)**

Parameters	Symbol	Min.	Тур.	Max.	Units	Conditions	
Temperature Ranges							
Junction Operating Temperature	TJ	_	_	+150	°C	—	
Storage Temperature Range	Τ <sub>S</sub>	-55	_	+150	°C	—	
Lead Temperature	—	—	+260	_	°C	Soldering, 40s	

**Note 1:** The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T<sub>A</sub>, T<sub>J</sub>, θ<sub>JA</sub>). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +150°C rating. Sustained junction temperatures above +150°C can impact the device reliability.

# 2.0 PIN DESCRIPTIONS

The DSA612 is a highly configurable device and can be factory programmed in many different ways to meet the customer's needs. Microchip's ClockWorks Configurator <a href="http://clockworks.microchip.com/Timing/">http://clockworks.microchip.com/Timing/</a> must be used to choose the necessary options, create the final part number, data sheet, and order samples. The descriptions of the pins are listed in Table 2-1.

Pin Number	Pin Name	Description					
	OE	Output Enable: H = Active, L = Disabled (High Impedance).					
	STDBY	Standby: H = Device is active, L = Device is in standby (Low Power Mode).					
	FS	Frequency Select: H = Output Frequency 1, L = Output Frequency 2.					
1	SLEEP	Sleep: H= Output Enabled, L= Output and associated PLL Disabled.					
	SSEN	Spread Spectrum: H = Enabled, L = Disabled.					
	NC	Non-functional, do not connect.					
	OE	Output Enable: H = Active, L = Disabled (High Impedance).					
	STDBY	Standby: H = Device is active, L = Device is in standby (Low Power Mode).					
2	FS	Frequency Select: H = Output Frequency 1, L = Output Frequency 2.					
	SLEEP	Sleep: H= Output Enabled, L= Output and associated PLL Disabled					
	NC	Non-functional, do not connect.					
3	VSS	Ground.					
4	CLK1	Factory configurable LVCMOS clock output 1: 2 kHz to 100 MHz, standard drive or high drive.					
5	CLK2	Factory configurable LVCMOS clock output 2: 2 kHz to 100 MHz, standard drive or high drive.					
6	VDD	Power Supply: 1.71V to 3.63V.					

TABLE 2-1: DSA612 PIN FUNCTION TABLE

An explanation of the different options listed in Table 2-1 follows:

#### 2.1 Pin 1 and Pin 2

These are control pins and each may be configured to fulfill one of six different functions. If not actively driven, a 10 k $\Omega$  pull-up resistor is recommended.

#### 2.1.1 OUTPUT ENABLE (OE)

Both pin 1 and pin 2 may be configured as Output Enable. Either or both outputs may be turned on and off according to the state of the pins.

#### 2.1.2 STANDBY

Either pin 1 or pin 2 (but not both) may be configured as standby. When the pin is low, both outputs will be off and the device will enter a low power mode.

#### 2.1.3 SLEEP

Either pin 1 or pin 2 (but not both) may be configured as sleep. When the pin is low, one phase lock loop (PLL) will shut down, enabling power saving. Any output driven by that PLL will be turned off.

# 2.1.4 SPREAD SPECTRUM ENABLE (SSEN)

Only pin 1 may be configured as SSEN. When the pin is high, the associated output will be spread in frequency. When the pin is low, no spreading will occur.

#### 2.1.5 FREQUENCY SELECT (FS)

Both pin 1 and pin 2 may be configured as FS. Each output may be set to one of two pre-programmed frequencies (four pre-programmed frequencies in total).

#### 2.1.6 NC

Both pin 1 and pin 2 may be configured as NC. In this case, the pins are non-functional and the device is programmed and fixed according to the choices in ClockWorks Configurator.

#### 2.2 Pins 3 through 6

Pins 3 and 6 are the supply terminals,  $V_{SS}$  and  $V_{DD}$  respectively. Pins 4 and 5 are the two clock outputs, CLK1 and CLK2, respectively. CLK1 and CLK2 outputs are programmable to Standard and High Drive strengths settings through ClockWorks Configurator.

### 3.0 SPREAD SPECTRUM

Spread spectrum is a slow modulation of the clock frequency over time. The PLL inside the MEMS oscillator is modulated with a triangular wave at 33 kHz. With such a slow modulation, the peak spectral energy of both the fundamental and all the harmonics is spread over a wider frequency range. This significantly reduces peak energy density, thus providing an EMI reduction. The triangular wave is chosen because of its flat spectral density.

The DSA612 MEMS oscillator family offers several modulation options: the spreading is either center spread or down spread with respect to the clock frequency. Center spreading ranges from  $\pm 0.25\%$  to  $\pm 2.5\%$ , while down spreading ranges from -0.25% to -3%.

If the clock frequency is 100 MHz and center spreading with  $\pm 1\%$  is chosen, the output clock will range from 99 MHz to 101 MHz. If down spreading with -2% is chosen, the output clock will range from 98 MHz to 100 MHz.

Figure 3-1 and Figure 3-2 show a spectrum example of the DSA612 with a 33.333 MHz clock, modulated with central spread of  $\pm 1\%$ .



FIGURE 3-1: DSA612 Spectrum at 33.333 MHz with Modulation Turned Off.



33.333 MHz with Modulation Turned On.

It is noticeable that the spread spectrum provides a reduction of about 10 dB from the peak power. Such a reduction may also be estimated by the following equation:

#### **EQUATION 3-1:**

EMI Reduction =  $10 \times Log 10(|S| \times fc \div RBW)$ 

Where:

- S Peak-to-peak spread percentage (0.01, this example).
- fc Carrier frequency (33.333 MHz, this example).
- RBW Resolution bandwidth of the spectrum analyzer (30 kHz, this example).

The theoretical calculation for this example provides 10.45 dB, which is consistent with the measurement.

Similarly to the fundamental frequency, all the harmonics are spread and attenuated in similar fashion. Figure 3-3 shows how the DSA612 fundamental at 33.333 MHz and its odd harmonics are attenuated when various types of modulations are selected. For picture clarity, only the center spread options are shown. However, down spread with corresponding percentage provides the same level of harmonic attenuation (e.g. central spread of  $\pm 1\%$  provides the same harmonics attenuation of down spread with -2%).



**FIGURE 3-3:** DSA612 Harmonic Levels with Various Spread Spectrum Options.

Visit Microchip's ClockWorks Configurator to select Spread Spectrum options.

# 4.0 OUTPUT WAVEFORM





# 5.0 BOARD LAYOUT



# 6.0 SOLDER REFLOW PROFILE





Solder Reflow Profile.

#### TABLE 6-1:SOLDER REFLOW

MSL 1 @ 260°C Refer to JSTD-020C							
Ramp-Up Rate (200°C to Peak Temp.)   3°C/sec. max.							
Preheat Time 150°C to 200°C	60 to 180 sec.						
Time Maintained above 217°C	60 to 150 sec.						
Peak Temperature	255°C to 260°C						
Time within 5°C of Actual Peak	20 to 40 sec.						
Ramp-Down Rate	6°C/sec. max.						
Time 25°C to Peak Temperature	8 minutes max.						

# 7.0 PACKAGING INFORMATION

## 7.1 Package Marking Information



Legend:	: XXX Y YY WW NNN @3 * •, ▲, ♥ mark).	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC <sup>®</sup> designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package. Pin one index is identified by a dot, delta up, or delta down (triangle
	be carried characters the corpor	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available of or customer-specific information. Package may or may not include ate logo. (_) and/or Overbar ( <sup>-</sup> ) symbol may not be to scale.

#### 6-Lead 1.6 mm x 1.2 mm VFLGA Package Outline and Recommended Land Pattern





Microchip Technology Drawing C04-1203A Sheet 2 of 2



# 6-Lead 2.0 mm x 1.6 mm VFLGA Package Outline and Recommended Land Pattern





Microchip Technology Drawing C04-1201A Sheet 2 of 2



### 6-Lead 2.5 mm x 2.0 mm VFLGA Package Outline and Recommended Land Pattern







# **DSA612**

NOTES:

# APPENDIX A: REVISION HISTORY

# **Revision A (October 2019)**

Initial release of DSA612 as Microchip data sheet DS20006263A.

# **DSA612**

NOTES:

# **PRODUCT IDENTIFICATION SYSTEM**

PART NO.	<u>X</u> │ Package	X │ Temperature	X   Frequency Stability	X │ Code Rev.	<u>-XX</u> Configu		X   Special Processing	X   Automotive Suffix			
Device:	DSA612		t Low Power MEI for Automotive	MS Clock	a) [ Two	o-Output I		MS Clock Generator for Auto			
Package:	R N P	= 6-Lead 2.0 n	nm x 2.0 mm VFL nm x 1.6 mm VFL nm x 1.2 mm VFL	_GA	±50 b) [ Two	<ul> <li>motive, 6-Lead 2.5 mm x 2.0 mm VFLGA, -40°C to +85°C ±50 ppm, 1st Revision, 1,000/Reel</li> <li>b) DSA612NL2A-2885VA0: Two-Output Low Power MEMS Clock Generator for Automotive, 6-Lead 2.0 mm x 1.6 mm VFLGA, -40°C to +105°C, ±25 ppm, 1st Revision, 100/Bag</li> <li>c) DSA612PA3A-8751BVA0: Two-Output Low Power MEMS Clock Generator for Automotive, 6-Lead 2.0 mm x 1.0 mm vFLGA, -40°C to +105°C, ±25 ppm, 1st Revision, 100/Bag</li> </ul>					
Temperature:	A L I	= -40°C to +10	25°C (Automotive 55°C (Automotive 5°C (Automotive	e Grade 2)	+10 c) [ Two						
Frequency Stability:	1 2 3	= ±50 ppm = ±25 ppm = ±20 ppm			+12	25°Ć, ±20 <b>e 1:</b> Ta	i-Lead 1.6 mm x 1.2 mm VFLGA, -40°C 20 ppm, 1st Revision, 3,000/Reel Tape and Reel identifier only appears in the catalog part number description. This identifier i				
Code Revision: Configuration Number:	A User-De	= 1st Revision		ator		us the Sa	ed for ordering p e device package	urposes and is not printed on . Check with your Microchip kage availability with the			
Special Processing:	<blank> <blank> T B</blank></blank>		Package Option & P Package Opt								
Automotive Suffix		Automotive Suffix Microchip.	in which "XX" is a	assigned by							
The DSA612 is a l the customer's ne choose the necess samples.	eds. Micro	ochip's ClockWo	rks Configurato	r must be use	ed to						

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# **DSA612**

NOTES:

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ISBN: 978-1-5224-5116-7

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